

10GBASE-SR XENPAK Module MM SC 300m data range (850nm) Cisco compatible



GBIC-, SFP-, XFP-, XENPAK-Transceiver

The tde Small Form Pluggable Optical Transceiver are easy installed for enterprise and telecom applications. The tde SFP modular line provides a fully compatible, highly reliable and volume accessible supply of quality transceiver products with excellent performance for design-in manufacturing and end-user enterprise applications.



tde[®] trans data elektronik GmbH

Headquarter address:

Lingener Str. 2
D-49626 Bippen/Ohrte
Tel.: +49 5435 9511 0
Fax.: +49 5435 9511 32

Sales office address:

Prinz-Friedrich-Karl-Str. 46
D-44135 Dortmund
Tel.: +49 231 8805 61 13
Fax.: +49 231 8805 61 15

info@tde.de | www.tde.de

10GBASE-SR XENPAK Module MM SC 300m data range (850nm) Cisco compatible

Technical Data

Features

- Up to 10GbD bi-directional data links
- Compliant with IEEE 802.3ae, 10GBASE-SR application
- Compliant with XENPAK MSA
- 850nm VCSEL laser
- PIN Photo-detector
- XAUI electrical interface: 4 lanes at 3.125GBd
- Hot Z-Pluggable
- SC Connectors
- Up to 300m on MMF
- Power Supply: 5V/3.3V/Adaptable Power Supply (APS: 1.2V)
- RoHS Compliance
- Operating temperature range: 0°C to 70°C

Applications

- 10GbD Ethernet

Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit	Remarks
Storage Ambient Temperature	TS	-40	85	°C	
Supply Voltage (3.3V)	V3	0	4	V	
Supply Voltage (APS)	VAPS	0	1.5	V	
Optical Receiver Input	PIMAX		1	dBm	Average

General Specifications

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remarks
Data Rate	DR		10.3125		GBD	
Bit Error Rate	BER			10-12		
Total Power Consumption	P			2.2	W	
Supply Voltage (+3.3V)	VCC3	3.14	3.3	3.47	V	Operating Environment
Supply Voltage (APS)	VCCAPS	1.152	1.2	1.248	V	Operating Environment
Supply Current (+3.3V)	ICC3			300	mA	
Supply Current (APS)	ICCAPS			1000	mA	
Case Operating Temperature	TC	0		70	°C	

10GBASE-SR XENPAK Module MM SC 300m data range (850nm) Cisco compatible

Link Distances

Parameter	Fiber Type	Modal Bandwidth at 850nm (MHz-km)	Distance Range (m)
10.3 GBd	62.5/125um MMF	160	2-26
10.3 GBd	62.5/125um MMF	200	2-33
10.3 GBd	50/125um MMF	400	2-66
10.3 GBd	50/125um MMF	500	2-82
10.3 GBd	50/125um MMF	2000	2-300

Optical Characteristics - Transmitter

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remarks
Optical Wavelength	λ	840	850	860	nm	
Launch Power	POUT	-7.3		-1.3	dBm	Average
Launch Power in OMA	POUT_OMA	-4.3		-2.8	dBm	
Launch Power of OFF Transmitter	POUT_OFF			-30	dBm	Average
Side Mode Suppression Ratio	SMSR	30			dB	
Spectral Width (RMS)	$\Delta\lambda$			0.45	nm	
Optical Extinction Ratio	ER	3			dB	
Optical Modulation amplitude	OMA	525			uW	
Optical Return Loss Tolerance	ORLT			12	dB	
Relative Intensity Noise	RIN			-128	dB/Hz	
Transmitter Dispersion Penalty	TDP			3.9	dB	
Eye Mask Definition						According to IEEE 802.3ae and 10GBASE-SR

Optical Characteristics - Receiver

Parameter	Symbol	Min.	Max.	Unit	Remarks
Center Wavelength Range	λ_C	840	860	nm	
Optical Input Power	PIN	-9.9	-1	dBm	Average, Informative
Receiver Sensitivity in OMA	PIN_OMA		-11.1	dBm	Informative
Stressed Receiver Sensitivity	PIN_S		-7.5	dBm	
Receiver Reflectance	TRRX		-12	dB	
Receiver electrical 3dB upper cutoff frequency	FR		12.3	Ghz	

10GBASE-SR XENPAK Module MM SC 300m data range (850nm) Cisco compatible

Electrical Characteristics - DC

	Parameter	Symbol	Min.	Typ.	Max.	Unit	Remarks
A. 1.2V COMS I/O DC Characteristics (PRTAD; LASI; RESET; TX_ON/ OFF)	External Pull-Up Resistor For Open Drain	RPU	10		22	kΩ	
	Output High Voltage	VOH	1			V	
	Output Low Voltage	VOL			0.15	V	
	Input High Voltage	VIH	0.84		1.2	V	
	Input Low Voltage	VIL			0.36	V	
	Input Pull-Down Current	IPD	20		120	μA	VIN=1.2V
B. XAUI I/O DC Charateristics (TXLANE[0..3]; RXLANE[0..3])	Differential Input Amplitude (pk-pk)	VIN_XAUI	200		1600	mV	AC Coupled
	Differential Output Amplitude (pk-pk)	VOUT_XAUI	800		1600	mV	AC Coupled
C. MDIO I/O DC Charateristics (MDIO; MDC)	Output Low Voltage	VOL			0.2	V	IOL=100uA
	Output Low Current	IOL			4	mA	
	Input High Voltage	VIH	0.84		1.2	V	
	Input Low Voltage	VIL			0.36	V	
	Pull-Up Supply Voltage	VPU		1.2		V	
	Input Capacitance	CIN			10	pF	
	Load Capacitance	CLOAD			470	pF	
	External Pull-Up Resistance	RPU	200			Ω	

Electrical Characteristics - AC

	Parameter	Symbol	Min.	Typ.	Max.	Unit	Remarks
A. XAUI Input AC Characteristics (TXLANE[0..3])	Baud Rate	BRXAUI_IN		3.125		GBd	
	Baud Rate Tolerance	BRTOL_XAUI	-100		100	ppm	
	Differential Input Impedance	ZIN_XAUI		100		Ω	

10GBASE-SR XENPAK Module MM SC 300m data range (850nm) Cisco compatible

	Differential Return Loss	RLIN	10			dB	100 MHz to 2.5 GHz
	Input Differential Skew	TIN_SKEW		75		ps	Crossing Point
	Jitter Amplitude Tolerance	JXAU_TO			0.65	UIPP	IEEE 802.3ae
B. XAU Output AC Charateristics (RXLANE[0..3])	Baud Rate	BRXAU_OUT		3.125		GBd	
	Baud Rate Variation	BRXAU_VAR	-100		100	ppm	
	XAU Eye Mask (far-end)	TOUT_SKEW					According to IEEE 802.3ae
	Output Differential Skew				15	ps	
	Output Differential Impedance	ZOUT_XAU		100		Ω	DC
	Differential Output Return Loss	RLOUT	10			dB	100 MHz to 2.5 GHz
	Total Jitter	TJXAU				UI	Near-end No pre-equalization 1 UI=320 ps
	Deterministic Jitter	DJXAU				UI	Near-end No pre-equalization 1 UI=320 ps
C. Power-On Reset Charateristics	Power-On Reset and TX_ONOFF Charateristics						According to XENPAK MSA Issue
D. MDIO I/O AC Charateristics (MDIO; MDC)	MDIO Data Hold Time	THOLD	10			ns	
	MDIO Data Setup Time	TSU	10			ns	
	Delay from MDC Rising Edge to MDIO Data Change	TDELAY			300	ns	
	MDC Clock Rate	fMAX			2.5	MHz	

Digital Diagnostic

Parameter	Symbol	Min.	Max.	Unit
Temperature Monitor	TMON	-5	+5	°C
Laser Bias Monitor	IMON	-10	10	%
TX Power Monitor	PTX	-3	+3	dBm
RX Power Monitor	PRX	-3	+3	dBm

Product variants & accessories

10GBASE-SR XENPAK Module MM SC 300m data range (850nm) Cisco compatible

Art.-No.	Description
TDE-XENPAK-10GB-SR	10GBASE-SR XENPAK Module MM SC 300m data range (850nm) Cisco compatible